

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

J1046 U.S. PTO  
09/848140  
05/03/01

Patent Application of Hideyo Esanai et al.

Title: *Metal-Ceramic Circuit Board and Manufacturing Method Thereof*

Attorney Docket: 134.136

Customer No.: 023907

#2  
D.G.  
8-1-01

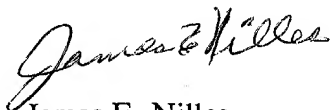
INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

This information disclosure statement is being submitted simultaneously with the filing of the above application under the provisions of 37 C.F.R. § 1.97 and § 1.98. Form PTO-1449 and copies of the listed references are enclosed.

Respectfully submitted,



James E. Nilles  
Registration No. 16,663

Dated: May 3, 2001

NILLES & NILLES, S.C.  
Firststar Center, Suite 2000  
777 East Wisconsin Avenue  
Milwaukee, WI 53202  
Telephone (414) 276-0977  
Facsimile (414) 276-0982  
ds G:\Data\CLIENT\134\136\IDS.doc